

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Densen Cao

Examiner: Ralph A. Lewis

Serial Number: 10/017,454

Group Art Unit: 3732

Filed: December 13, 2001

For: "Improved Semiconductor Curing Light System Useful for Curing Light Activated Composite Materials"

DOCKET: 5061 P

**CERTIFICATE OF MAILING**


Mail Stop: NON-FEE AMENDMENT  
Commissioner for Patents  
P. O. Box 1450  
Alexandria, Virginia 22313-1450

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TECHNOLOGY CENTER R3700

Honorable Commissioner:

I hereby certify that the attached Response to Office Action is being submitted via First Class Mail with the United States Postal Service in an envelope with sufficient postage addressed to: "Mail Stop: NON-FEE AMENDMENT, Commissioner for Patents, P. O. Box 1450, Alexandria, Virginia 22313-1450" on this 14<sup>th</sup> day of June, 2004.

Respectfully submitted this 14th day of June, 2004.

  
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